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MICROWAVE CORPORATION v03.0914



HMC844LC4B

45 Gbps, XOR / XNOR
w/ PROGRAMMABLE OUTPUT VOLTAGE

Typical Applications

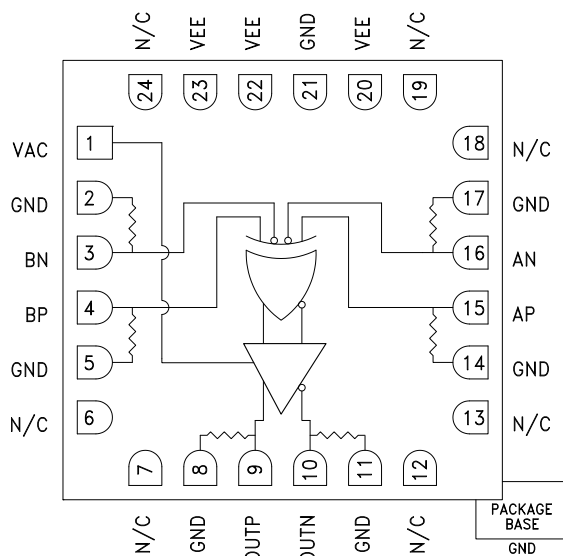
The HMC844LC4B is ideal for:

- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 45 Gbps
- Digital Logic Systems up to 25 GHz

Features

Supports High Data Rates: up to 45 Gbps
Differential & Single-Ended Operation
Fast Rise and Fall Times: 11 / 10 ps
Low Power Consumption: 510 mW
Programmable Differential
Output Voltage Swing: 200 - 850 mVp-p
Single Supply: -3.3V
24 Lead 4x4 mm SMT Package: 16 mm²

Functional Diagram



General Description

The HMC844LC4B is an XOR/XNOR function designed to support data transmission rates of up to 45 Gbps, and clock frequencies as high as 25 GHz. The HMC844LC4B may be easily configured to provide either XOR or XNOR logic functions. The HMC844LC4B also features an output level control pin, VAC, which allows for loss compensation or for signal level optimization.

All input signals to the HMC844LC4B are terminated with 50 Ohms-to-ground on-chip, and may be either AC or DC coupled. The differential outputs of the HMC844LC4B may be either AC or DC coupled. Outputs can be connected directly to a 50 Ohms-to-ground terminated system, while DC blocking capacitors should be used if the terminating system is 50 Ohms to a non-ground DC voltage. The HMC844LC4B operates from a single -3.3V DC supply, and is available in a ceramic RoHS compliant 4x4 mm SMT package.

Electrical Specifications, $T_A = +25^\circ\text{C}$, $V_{ee} = -3.3\text{V}$

Parameter	Conditions	Min.	Typ.	Max	Units
Power Supply Voltage	$\pm 5\%$ Tolerance	-3.47	-3.3	-3.13	V
Power Supply Current	VAC = -0.3V	140	155	170	mA
Output Amplitude Control Voltage (VAC) ^[1]		-1.7	-0.3	-0.1	V
Maximum Data Rate		45			Gbps
Maximum Clock Rate		25			GHz
Input Amplitude	Single-ended, peak-to-peak	100		300	mVp-p
	Differential, peak-to-peak	100		1000	
Input High Voltage		-0.5		0.5	V
Input Low Voltage		-1		0	V
Output Amplitude	Differential, peak-to-peak @ 40 Gbps	200		850	mVp-p

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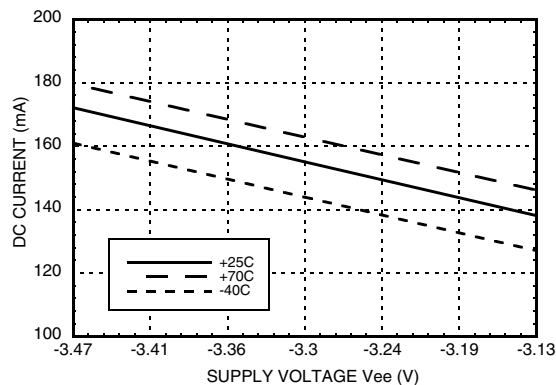
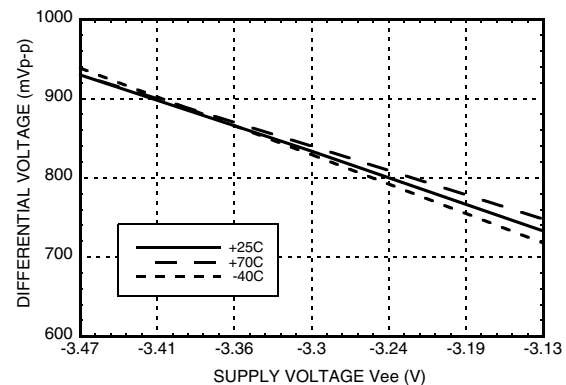
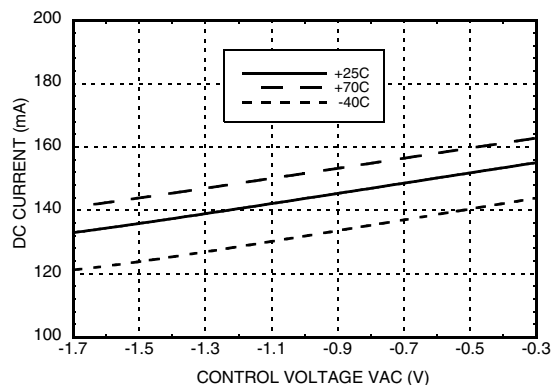
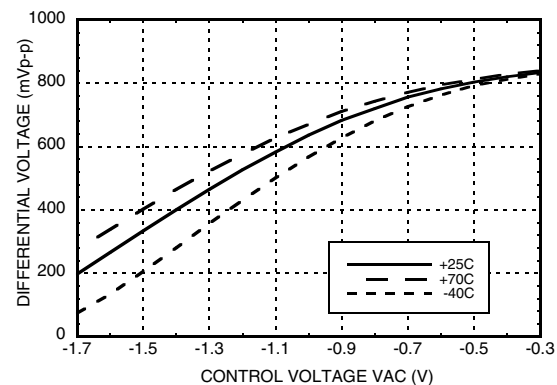
Electrical Specifications, (continued)

Parameter	Conditions	Min.	Typ.	Max	Units
Output High Voltage		VAC = -0.3	-10		mV
Output Low Voltage		VAC = -0.3	-430		mV
Input Return Loss	Frequency < 25 GHz		8		dB
Output Return Loss	Frequency < 25 GHz		8		dB
Deterministic Jitter, Jd ^[2]			3		ps, pp
Additive Random Jitter Jr ^[3]			0.2		ps rms
Rise Time, tr ^[2]	VAC = -0.3V		11		ps
Fall Time, tf ^[2]	VAC = -0.3V		10		ps
Propagation Delay, td	@ 40 Gbps		90		ps

[1] VAC = VC2 on evaluation board

[2] A Input: 40 Gbps PRBS 2²³-1 pattern, 200 mVp-p single-ended, B Input: 40 Gbps 10101... pattern, 200 mVp-p single-ended

[3] Random jitter is measured with 40 Gbps 10101... pattern

DC Current vs. Supply Voltage ^{[1] [2]}

Differential Output Swing vs. Supply Voltage ^{[1] [2]}

DC Current vs. VAC ^[2]

Differential Output Swing vs. VAC ^[2]


[1] VAC = -0.3V

[2] Input data rate: 40 Gbps PRBS 2²³-1 pattern



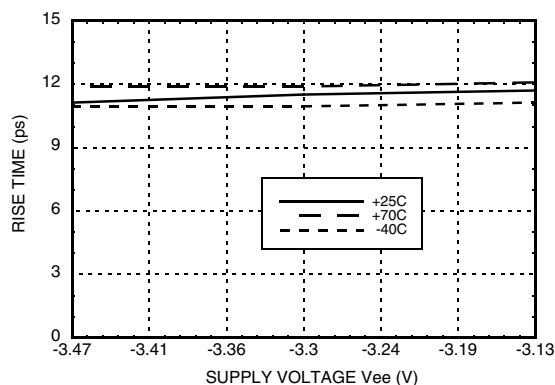
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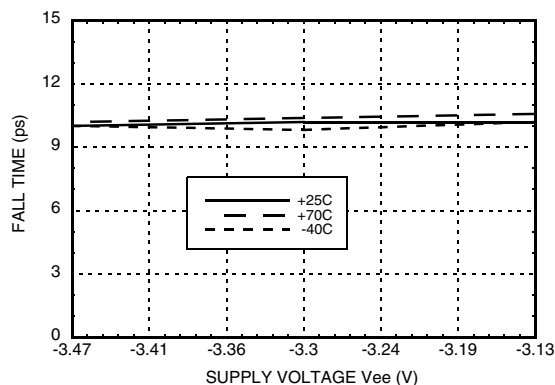
HMC844LC4B

**45 Gbps, XOR / XNOR
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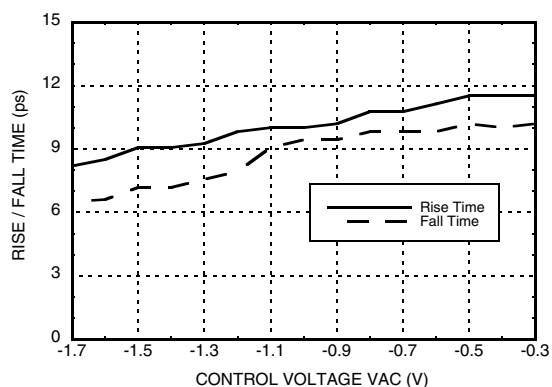
Rise Time vs. Supply Voltage [1][2][3]



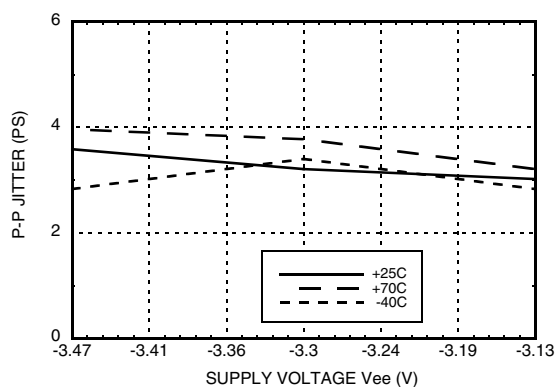
Fall Time vs. Supply Voltage [1][2][3]



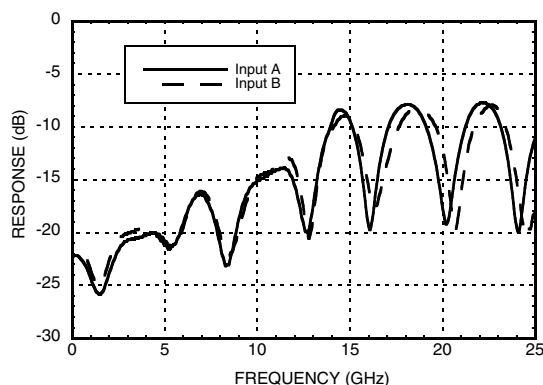
Rise / Fall Time vs. VAC [1][2][3]



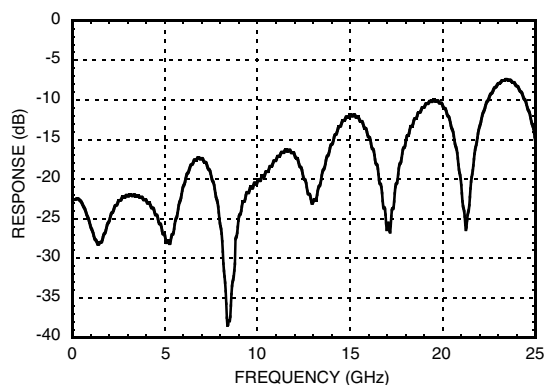
Peak-to-Peak Jitter vs. Supply Voltage [1][2][3][4]



Input Return Loss vs. Frequency [1][5]

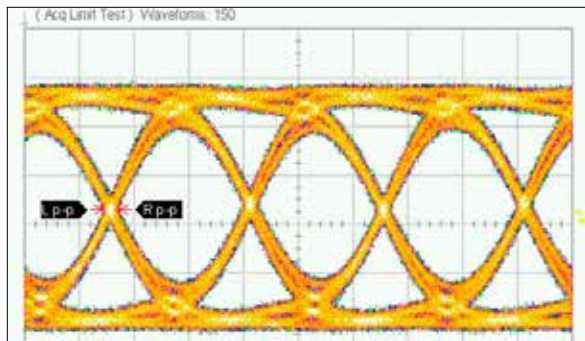


Output Return Loss vs. Frequency [1][5]



[1] VAC = -0.3V [2] Input data rate: 40 Gbps PRBS 2²³-1 pattern [3] Data was taken at single ended output
[4] Source jitter was not deembedded [5] Device measured on evaluation board with single-ended time domain gating.

40 Gbps Differential Output Eye Diagram

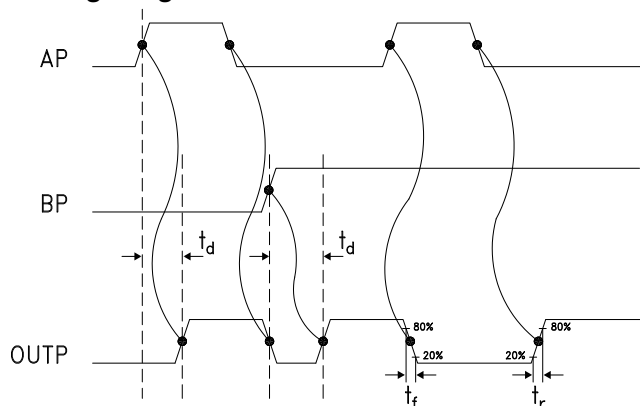


Measurements				
	Current	Min	Max	Total Meas.
Eye Amp	811 mV	811 mV	813 mV	39
Rise Time	12.89 ps	12.67 ps	12.89 ps	39
Fall Time	13.78 ps	13.56 ps	13.78 ps	39
p-p Jitter	3.111 ps	3.111 ps	3.111 ps	39

Time Scale: 10 ps/div
Amplitude Scale: 200 mV/div

Test Conditions:
Vee = -3.3V, VAC = -0.3V
A Input: 40 Gbps PRBS 2²³-1 pattern, 150 mVp-p single-ended
B Input: 40 Gbps 10101... pattern, 150 mVp-p single-ended

Timing Diagram



Truth Table

Input		Outputs
A	B	D
L	L	L
L	H	H
H	L	H
H	H	L
Notes: A = AP - AN B = BP - BN D = OUTP - OUTN		H - Logic High L - Logic Low



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**HMC844LC4B**

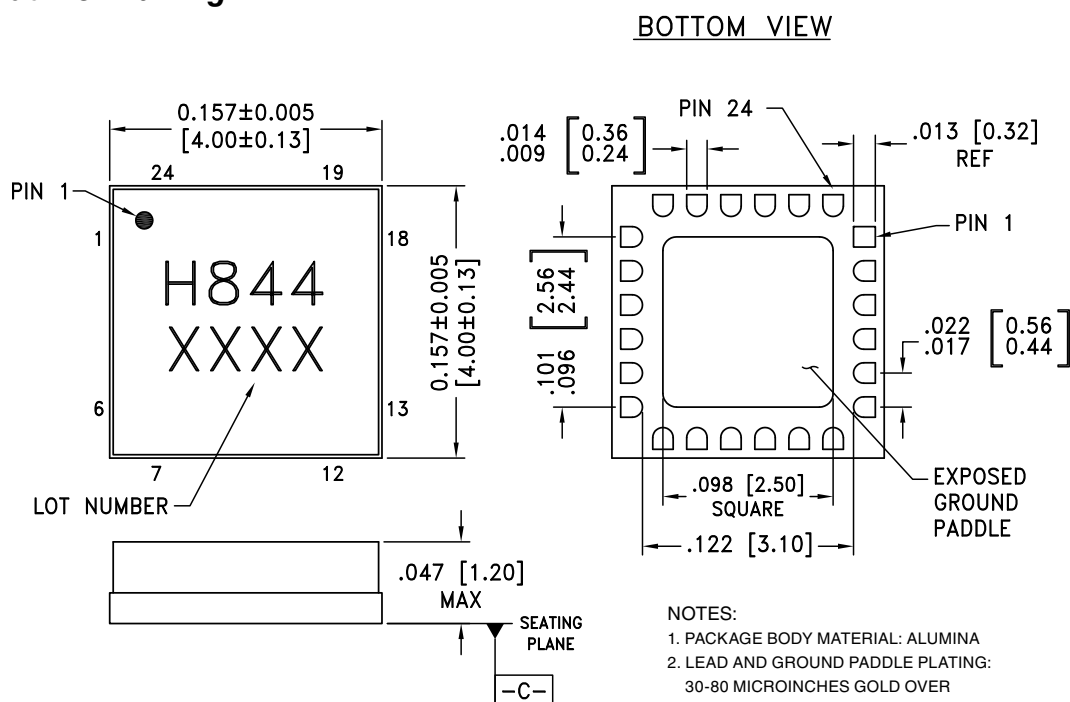
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Absolute Maximum Ratings

Power Supply Voltage (Vee)	-3.7V to +0.5V
Input Voltage	-1.3V to +0.5V
Output Amplitude	-2.3V to +0.5V
Control Voltage (VAC)	-2.3V to +0.5V
Channel Temperature	125°C
Continuous Pdiss (T = 85°C) (derate 24.42 mW/°C above 85°C)	0.98 W
Thermal Resistance (channel to ground paddle)	40.95 °C/W
Storage Temperature	-65°C to +125°C
Operating Temperature	-40°C to +70°C
ESD Level (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing**NOTES:**

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING:
30-80 MICROINCHES GOLD OVER
50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM **-C-**
6. ALL GROUND LEADS AND GROUND PADDLE
MUST BE SOLDERED TO PCB RF GROUND.

Package Information

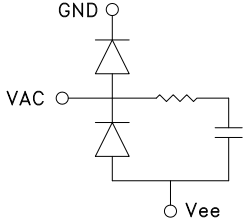
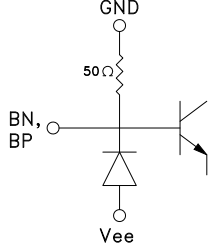
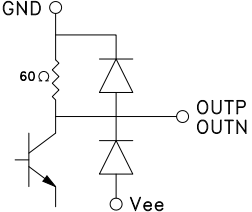
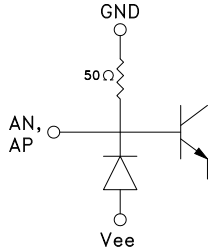
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC844LC4B	Alumina, White	Gold over Nickel	MSL3 ^[1]	H844 XXXX

[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX

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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	VAC	Output amplitude control voltage Note: VAC = VC2 on evaluation board	
2, 5, 8, 11, 14, 17, 21 Package Base	GND	Signal and supply grounds	
3, 4	BN, BP	Differential (BP-BN) or single-ended (BP) data inputs	
6, 7, 12, 13, 18, 19, 24	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
9, 10	OUTP, OUTN	XOR / XNOR outputs	
15, 16	AP, AN	Differential (AP-AN) or single-ended (AP) data inputs	
20, 22, 23	Vee	Power Supply (-3.3V)	



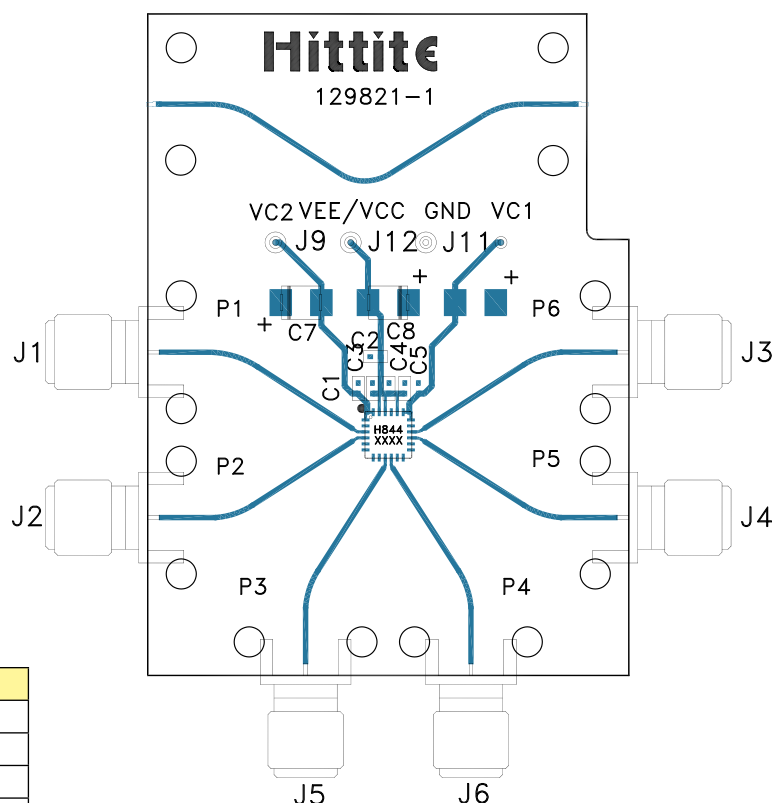
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Evaluation PCB



Note: VC2 on evaluation board is VAC.

Item	Description
J1	BN
J2	BP
J3	AN
J4	AP
J5	OUTP
J6	OUTN
J9	VAC
J11	GND
J12	Vee

List of Materials for Evaluation PCB 129821 [1]

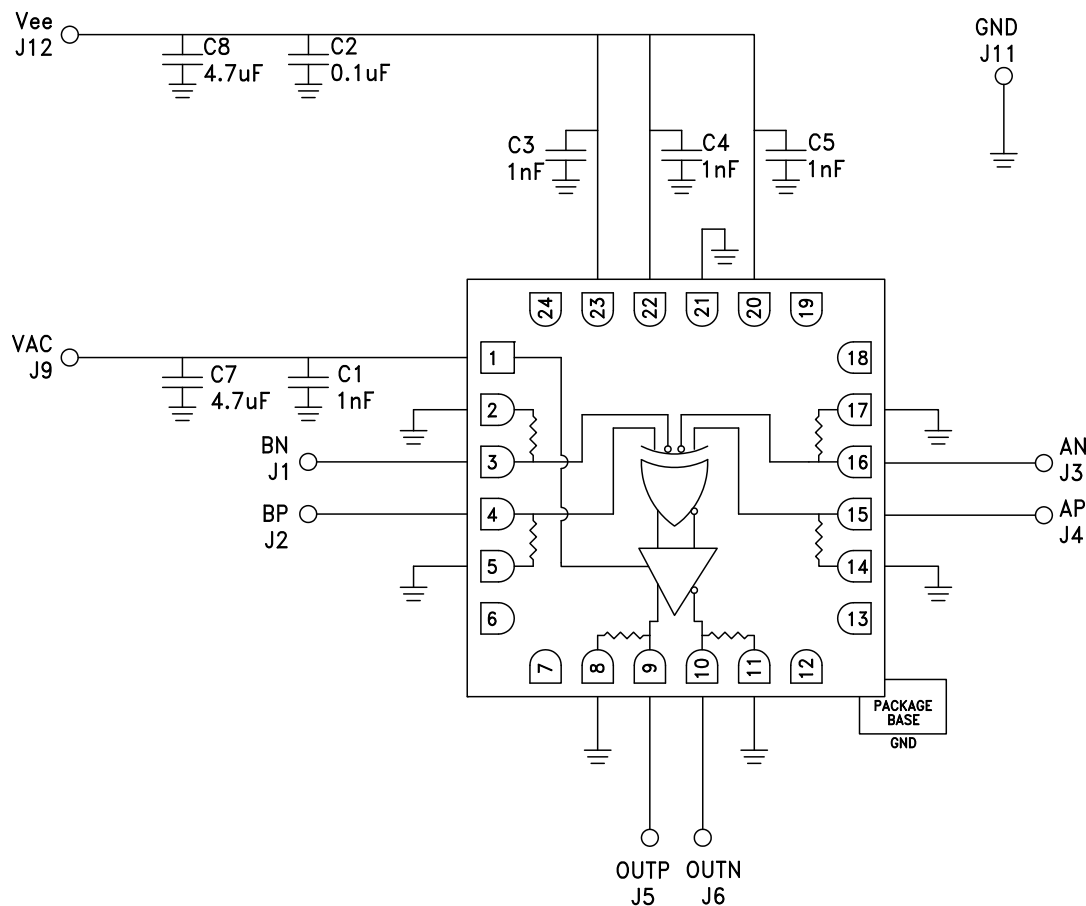
Item	Description
J1 - J6	K Connector
J9, J11, J12	DC Pin
C1, C3 - C5	1000 pF Capacitor, 0402 Pkg.
C2	0.1 μ F Capacitor, 0402 Pkg.
C7, C8	4.7 μ F Capacitor, Tantalum
U1	HMC844LC4B XOR / XNOR
PCB [2]	129821 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed metal package base must be connected to Vee. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Application Circuit



Note: VAC (J9) = VC2 on evaluation board.